



SEIP - Software Engineering in Practice

ICSE 2022

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Call for Papers

The Software Engineering in Practice (SEIP) Track is the premier venue for practitioners and researchers to discuss insights, innovations, and solutions to concrete software engineering problems. Practical software development relies on excellent software engineering research.

SEIP provides a unique forum for networking, exchanging ideas, fostering innovations, and forging long-term collaborations to address Software Engineering research that impacts directly on practice. It is one of the most prestigious forums in which to publish work in the Software Engineering literature. SEIP will include participants and speakers from both industrial and academic sectors, drawing together researchers and practitioners eager to communicate and share common interests in software engineering. The track will be composed of invited talks, paper presentations, and interactive sessions, all with a strong focus on software practice.

Please note that the ICSE SEIP track does NOT require double-anonymous review. Unlike other ICSE tracks, it is often important for SEIP paper authors and the organisations involved to be visible to the reviewers in order for the reviewers to fully understand the industrial relevance and context.

Submissions

We seek the following two types of submission, both of which must be written exclusively in English and for which paper limits include references.

Full papers (up to 10 pages)

Full papers address industrially-relevant problems through systematic investigations. Each paper should describe a problem of practical importance, explain how the problem was investigated and in what context, and present evidence for the paper's conclusions. The submission should have technical and empirical soundness. Other aspects that should also be included where appropriate include: discussing why the resolution of the problem is innovative, (cost-) effective, or efficient; providing a concise explanation of the approach, techniques, and methodologies employed; and explaining the insights or best practices that emerged, tools developed, and/or software processes involved.

Full papers will appear in the ICSE SEIP Companion proceedings.

Industrial Challenge papers (up to 2 pages)

Industrial challenge papers outline a new research challenge, arising from industrial software practice and experience. A challenge paper will clearly articulate the problem and motivate it in terms of its potential for industrial impact and/or its practical importance. The aim of the call for challenge papers is to provide a growing pool of well-defined industrially relevant problems for the research community to tackle.

Industrial challenge papers will appear in the ICSE SEIP Companion proceedings.

Formatting and Submission Links

Formatting instructions are available at <https://www.acm.org/publications/proceedings-template> (<https://www.acm.org/publications/proceedings-template>) for both LaTeX and Word users. LaTeX users must use the provided `acmart.cls` and `ACM-Reference-Format.bst` without modification, enable the conference format in the preamble of the document (i.e., `\documentclass[sigconf,review]{acmart}`), and use the ACM reference format for the bibliography (i.e., `\bibliographystyle{ACM-Reference-Format}`). The review option adds line numbers, thereby allowing referees to refer to specific lines in their comments.

SEIP does NOT use double-anonymous review. All SEIP papers must be written in English. All SEIP papers should be made accessible to people with disabilities. Guidelines (from the folks at SIGACCESS) can be found here: https://assets21.sigaccess.org/creating_accessible_pdfs.html (https://assets21.sigaccess.org/creating_accessible_pdfs.html).

All SEIP papers must be submitted through EasyChair, using the following link:
<https://easychair.org/conferences/?conf=icseseip2022> (<https://easychair.org/conferences/?conf=icseseip2022>)

Evaluation

All SEIP submissions will be reviewed by members of the SEIP Program Committee. Submissions will be evaluated based on relevance to industrial practice, the significance of contribution, and the quality of presentation.

By submitting to this track, authors acknowledge that they are aware of and agree to be bound by the ACM Policy and Procedures on Plagiarism (<https://www.acm.org/publications/policies/plagiarism>) and the IEEE Plagiarism FAQ (<https://www.ieee.org/publications/rights/plagiarism/plagiarism-faq.html>). In particular, papers submitted to ICSE 2022 SEIP must not have been published elsewhere and must not be under review or submitted for review elsewhere whilst under consideration for ICSE SEIP 2022. Contravention of this concurrent submission policy will be deemed a serious breach of scientific ethics, and appropriate action will be taken in all such cases. To check for double submission and plagiarism issues, the chairs reserve the right to (1) share the list of submissions with the PC Chairs of other conferences with overlapping review periods and (2) use external plagiarism detection software, under contract to the ACM or IEEE, to detect violations of these policies.

By submitting to this track, authors acknowledge that they conform to the authorship policy of the ACM (<https://www.acm.org/publications/policy-on-authorship>), and the authorship policy of the IEEE (<https://journals.ieeeauthorcenter.ieee.org/become-an-ieee-journal-author/publishing-ethics/definition-of-authorship/>).

Important Dates

SEIP Paper Submission Deadline: 15 October 2021.

SEIP Paper Acceptance Notification: 14 January 2022.

SEIP Paper Camera Ready Copy Due: 11 February 2022.







Conference Attendance Expectation

If a submission is accepted, at least one author of the paper is required to present the paper. The presentation can be in person, or possibly performed virtually, due to travel limitations (related to, e.g., health, visa, or COVID-19 constraints).

Contact

If there are queries regarding the CFP, please contact the ICSE SEIP 2022 chairs (Mark Harman and Heather Miller): icseseip2022@easychair.org (<mailto:icseseip2022@easychair.org>)

Important Dates	🌐🕒 AoE (UTC-12h)
Fri 11 Feb 2022 Paper Camera Ready Copy Due	
Fri 14 Jan 2022 Paper Acceptance Notification	
Fri 15 Oct 2021 Paper Submission Deadline	

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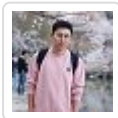
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